

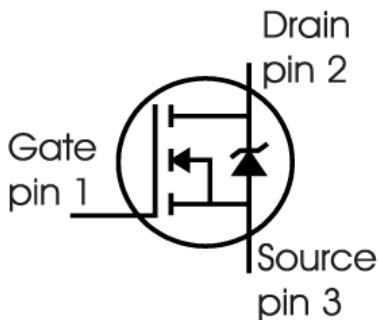


RTW77N60SD

Super Junction MOSFETs

■ Rongtech has series Multi-EPI Super-Junction power MOSFET platforms for voltage up 500V to 1000 volts, both with design service and manufacturing capability, including cell, termination design and simulation.

The RTW600V 77A power MOSFET is a Low voltage N channel Multi-EPI Super-Junction power MOSFET sample with advanced technology to have better characteristics, such as fast switching time, low C_{iss} and C_{rss} , low on resistance and excellent avalanche characteristics, making it especially suitable for applications which require superior power density and outstanding efficiency.



ORDERING INFORMATION

Industrial Range: -40° C to +125° C

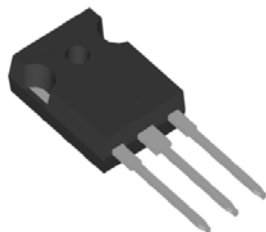
■ Features

- New revolutionary high voltage technology
- Better $R_{DS(on)}$ in TO-247
- Ultra Low gate charge
- Periodic avalanche rated
- Extreme dv/dt rated
- Ultra low effective capacitances
- Intrinsic fast-recovery body diode
- Pb-free lead planting
- $R_{DS(on)} = 0.041\Omega$ @ $V_{GS} = 10V$
 $V_{DS} = 600V$
 I_D (@ $V_{GS}=10V$) = 35A

APPLICATIONS

- Consumer
- EV Charger
- PFC stages for server & telecom
- SMPS
- UPS
- Solar
- Lighting

| Order Part No. | Package |
|----------------|-----------------|
| RTW77N60SD | TO-247, Pb-Free |
| RTP77N60SD | TO-3P, Pb-Free |



TO-247



TO-3P



RTW77N60SD Super Junction MOSFETs

Maximum rating sat $T_j = 25^\circ\text{C}$, unless otherwise specified.

| Symbol | Parameter | RTW77N60SD | Unit |
|----------------|--|-------------|------------------|
| V_{DSS} | Drain-Source Voltage | 600 | V |
| I_D | Drain Current -Continuous ($T_C = 25^\circ\text{C}$) -Continuous ($T_C = 100^\circ\text{C}$) | 77* 45* | A |
| I_{DM} | Drain Current - Pulsed (Note 1) | 260 | A |
| V_{GSS} | Gate-Source voltage | ± 30 | V |
| E_{AS} | Single Pulsed Avalanche Energy (Note 2) | 1950 | mJ |
| I_{AR} | Repetitive Avalanche Current (Note 1) | 13 | A |
| E_{AR} | Repetitive Avalanche Energy (Note 1) | 2.5 | mJ |
| dv/dt | Peak Diode Recovery dv/dt (Note 3) | 15 | V/ns |
| dV_{ds}/dt | Drain Source voltage slope ($V_{ds}=480\text{V}$) | 50 | V/ns |
| P_D | Power Dissipation ($T_C = 25^\circ\text{C}$) | 400 | W |
| T_J, T_{STG} | Operating and Storage Temperature Range | -55 to +150 | $^\circ\text{C}$ |
| T_L | Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds | 300 | $^\circ\text{C}$ |

1) Limited by $T_{j,max}$. Maximum duty cycle $D=0.75$

2) Pulse width t_p limited by $T_{j,max}$

3) Identical low side and high side switch with identical R_G ; $V_{peak} < V(BR)_{DSS}$; $T_j < T_{j,max}$

Thermal Characteristics

| Symbol | Parameter | RTW77N60SD | Unit |
|-----------------|---|------------|--------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | 0.32 | $^\circ\text{C/W}$ |
| $R_{\theta CS}$ | Thermal Resistance, Case-to-Sink Typ. | 0.5 | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | 62 | $^\circ\text{C/W}$ |



RTW77N60SD Super Junction MOSFETs

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|---|---|-----|------------|--------|----------|
| Off Characteristics | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} = 0V, I _D = 250μA, T _J = 25°C | 600 | -- | -- | V |
| | | V _{GS} = 0V, I _D = 250μA, T _J = 150°C | -- | 650 | -- | V |
| ΔBV _{DSS} /ΔT _J | Breakdown Voltage Temperature Coefficient | I _D = 250μA, Referenced to 25°C | -- | 0.6 | -- | V/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = 600V, V _{GS} = 0V -T _J = 25°C -T _J = 150°C | -- | -- 1000 | 4 - | μA μA |
| I _{GSSF} | Gate-Body Leakage Current, Forward | V _{GS} = 30V, V _{DS} = 0V | -- | -- | 100 | nA |
| I _{GSSR} | Gate-Body Leakage Current, Reverse | V _{GS} = -30V, V _{DS} = 0V | -- | -- | -100 | nA |
| On Characteristics | | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} = V _{GS} , I _D = 250μA | 2.5 | -- | 4.5 | V |
| R _{DS(on)} | Static Drain-Source On-Resistance | V _{GS} = 10V, I _D = 35A | -- | 35 | 41 | mΩ |
| g _{FS} | Forward Transconductance | V _{DS} = 40V, I _D = 35A | -- | 30 | -- | S |
| Dynamic Characteristics | | | | | | |
| C _{iss} | Input Capacitance | V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz | -- | 6200 | - | pF |
| C _{oss} | Output Capacitance | | -- | 300 | - | pF |
| C _{rss} | Reverse Transfer Capacitance | | -- | 12 | -- | pF |
| Switching Characteristics | | | | | | |
| t _{d(on)} | Turn-On Delay Time | V _{DD} = 480V, I _D = 35A R _G = 20Ω (Note 4) | -- | 39 | -- | ns |
| t _r | Turn-On Rise Time | | -- | 20 | -- | ns |
| t _{d(off)} | Turn-Off Delay Time | | -- | 100 | -- | ns |
| t _f | Turn-Off Fall Time | | -- | 5 | -- | ns |
| Q _g | Total Gate Charge | V _{DS} = 480V, I _D = 35A V _{GS} = 10V (Note 4) | -- | 300 | - | nC |
| Q _{gs} | Gate-Source Charge | | -- | 59 | -- | nC |
| Q _{gd} | Gate-Drain Charge | | -- | 195 | -- | nC |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| I _S | Maximum Continuous Drain-Source Diode Forward Current | | -- | -- | 77 | A |
| I _{SM} | Maximum Pulsed Drain-Source Diode Forward Current | | -- | -- | 260 | A |
| V _{SD} | Drain-Source Diode Forward Voltage | V _{GS} = 0V, I _S = 35A | -- | 0.9 | 1.5 | V |
| t _{rr} | Reverse Recovery Time | V _{GS} = 0V, I _S = 35A dI _F /dt = 100A/μs | -- | 250 | -- | ns |
| Q _{rr} | Reverse Recovery Charge | | -- | 19 | -- | μC |

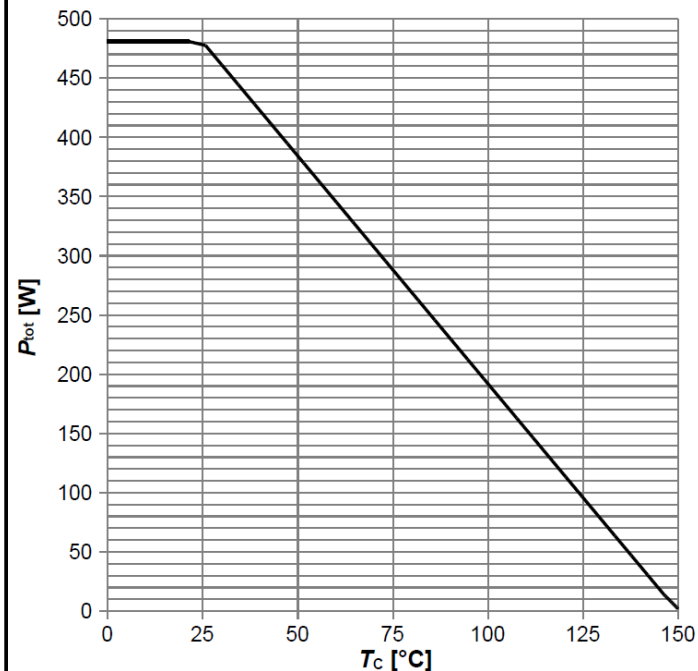
1) Co(er) is a fixed capacitance that gives the same stored energy as Coss while VDS is rising from 0 to 80% V(BR)DSS

2) Co(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 to 80% V(BR)DSS



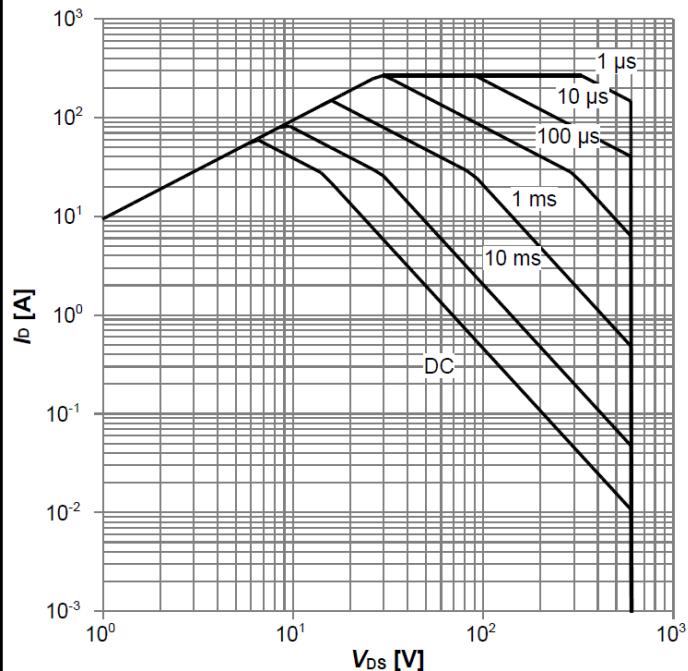
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Diagram 1: Power dissipation



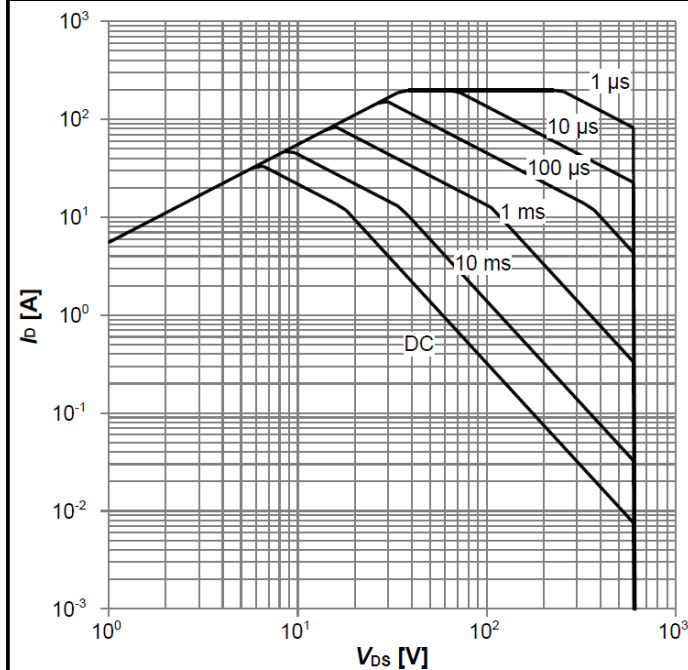
$$P_{tot}=f(T_c)$$

Diagram 2: Safe operating area



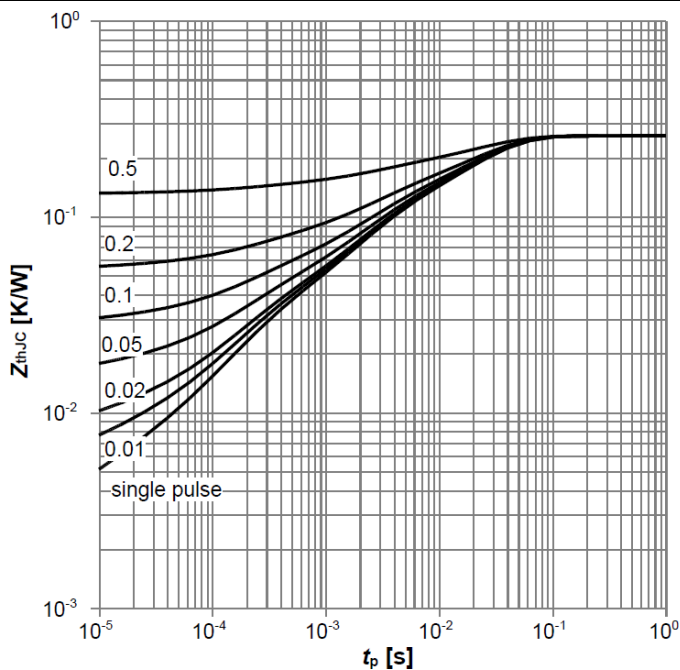
$$I_D=f(V_{DS}); T_c=25^\circ\text{C}; D=0; \text{parameter: } t_p$$

Diagram 3: Safe operating area



$$I_D=f(V_{DS}); T_c=80^\circ\text{C}; D=0; \text{parameter: } t_p$$

Diagram 4: Max. transient thermal impedance

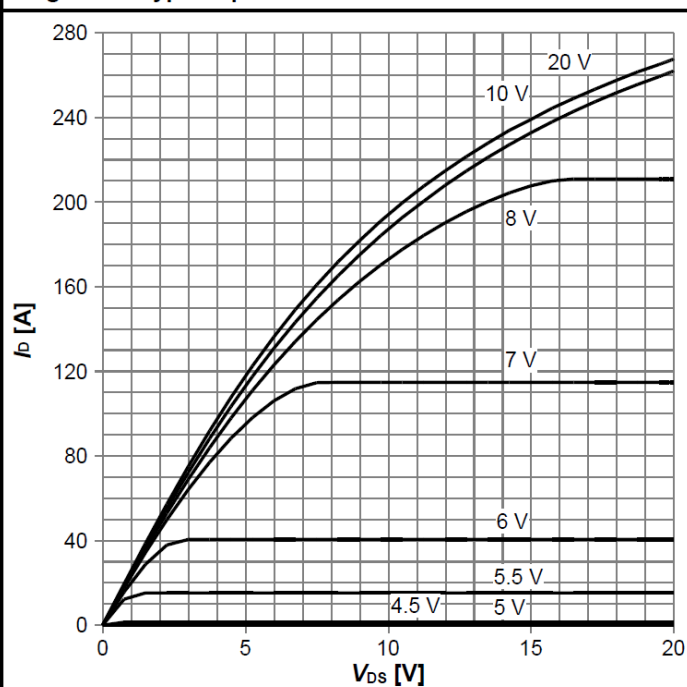


$$Z_{thJC}=f(t_p); \text{parameter: } D=t_p/T$$



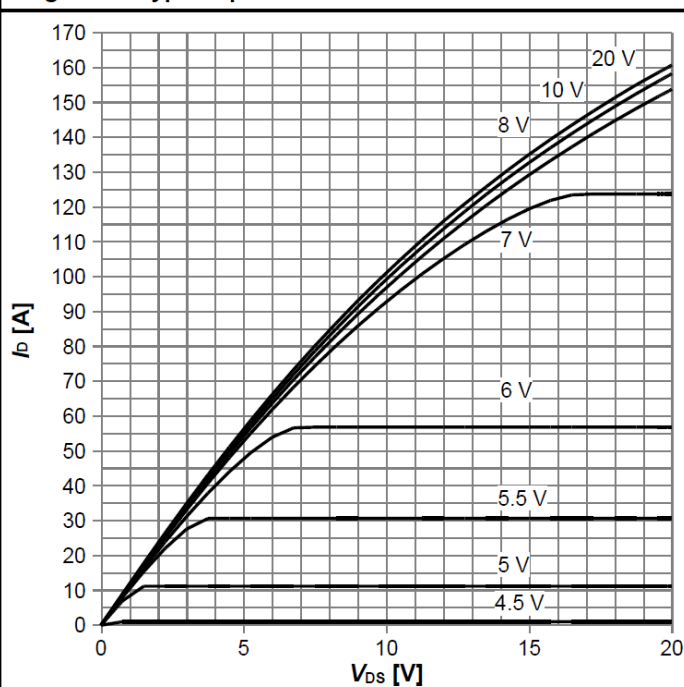
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Diagram 5: Typ. output characteristics



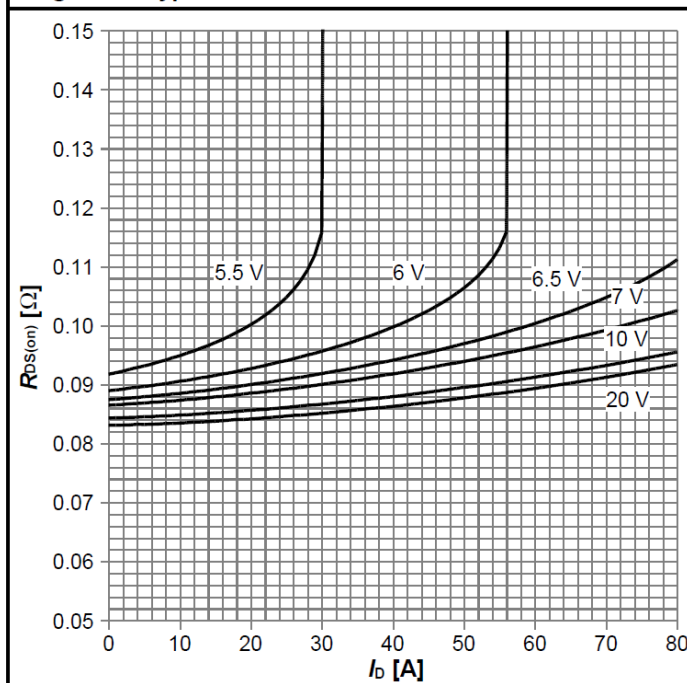
$I_D = f(V_{DS})$; $T_j = 25^\circ\text{C}$; parameter: V_{GS}

Diagram 6: Typ. output characteristics



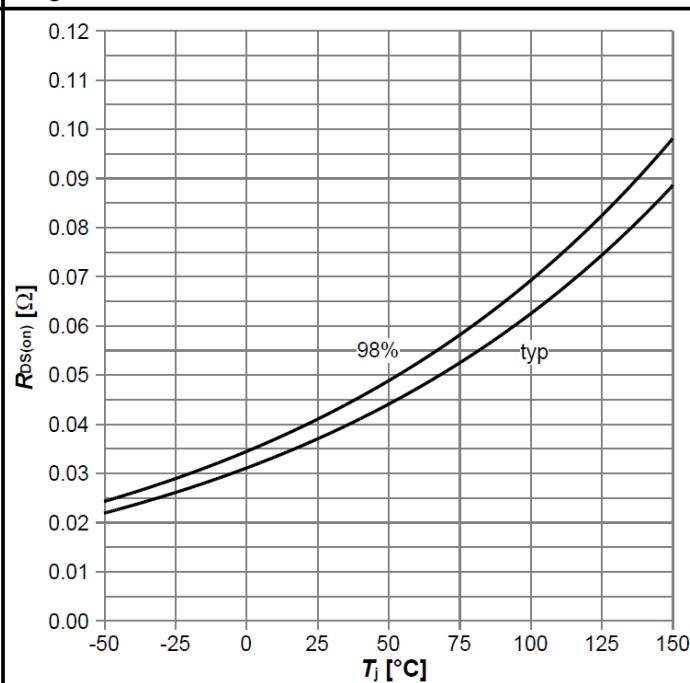
$I_D = f(V_{DS})$; $T_j = 125^\circ\text{C}$; parameter: V_{GS}

Diagram 7: Typ. drain-source on-state resistance



$R_{DS(on)} = f(I_D)$; $T_j = 125^\circ\text{C}$; parameter: V_{GS}

Diagram 8: Drain-source on-state resistance

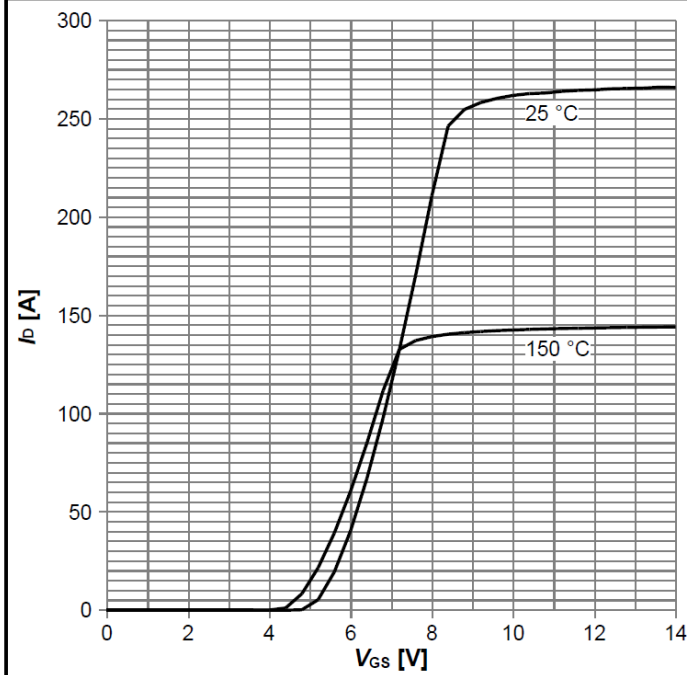


$R_{DS(on)} = f(T_j)$; $I_D = 35.5\text{ A}$; $V_{GS} = 10\text{ V}$



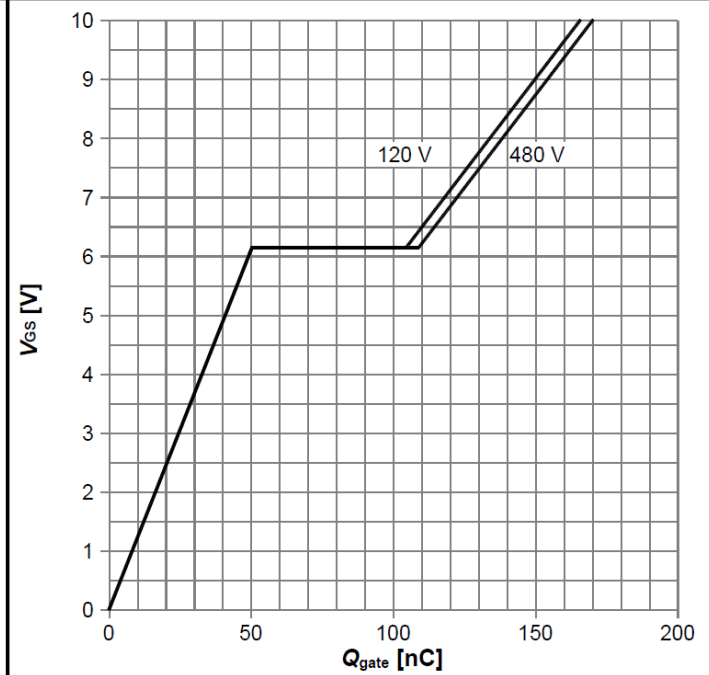
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Diagram 9: Typ. transfer characteristics



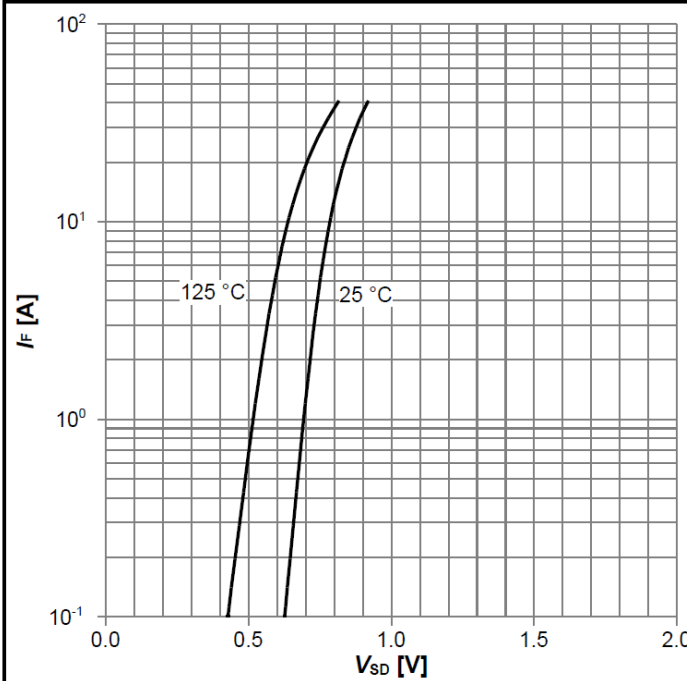
$I_D = f(V_{GS})$; $V_{DS} = 20\text{ V}$; parameter: T_j

Diagram 10: Typ. gate charge



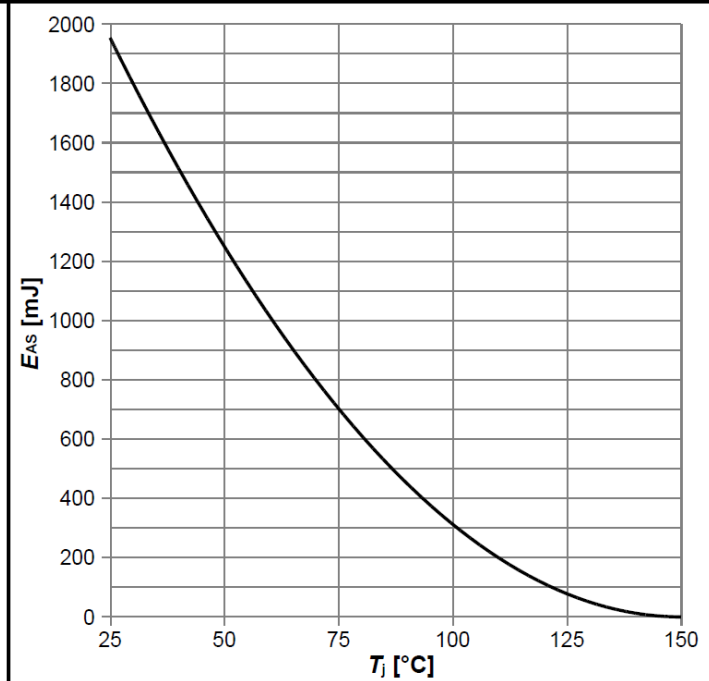
$V_{GS} = f(Q_{gate})$; $I_D = 44.4\text{ A}$ pulsed; parameter: V_{DD}

Diagram 11: Forward characteristics of reverse diode



$I_F = f(V_{SD})$; parameter: T_j

Diagram 12: Avalanche energy

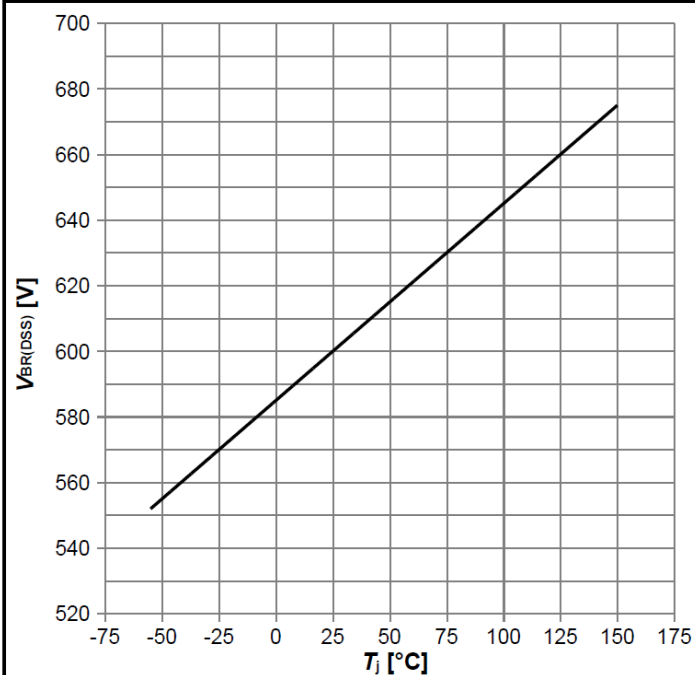


$E_{AS} = f(T_j)$; $I_D = 13.4\text{ A}$; $V_{DD} = 50\text{ V}$



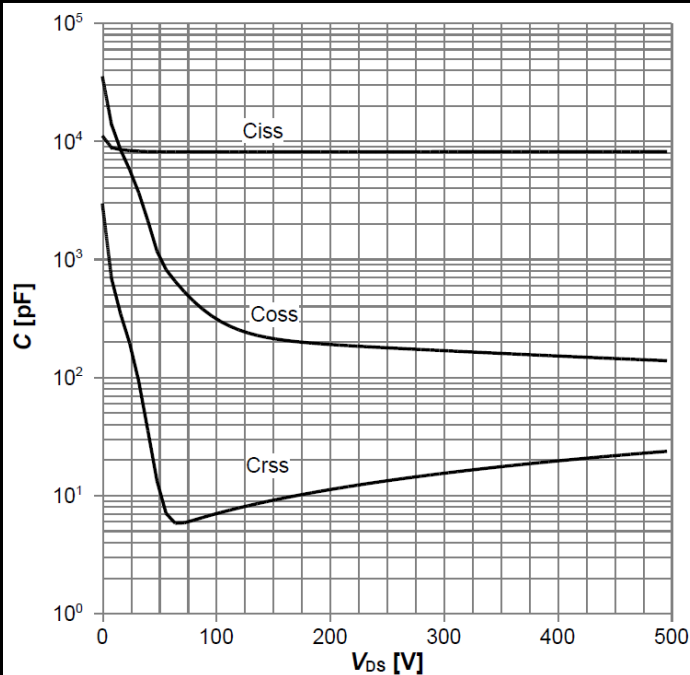
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Diagram 13: Drain-source breakdown voltage



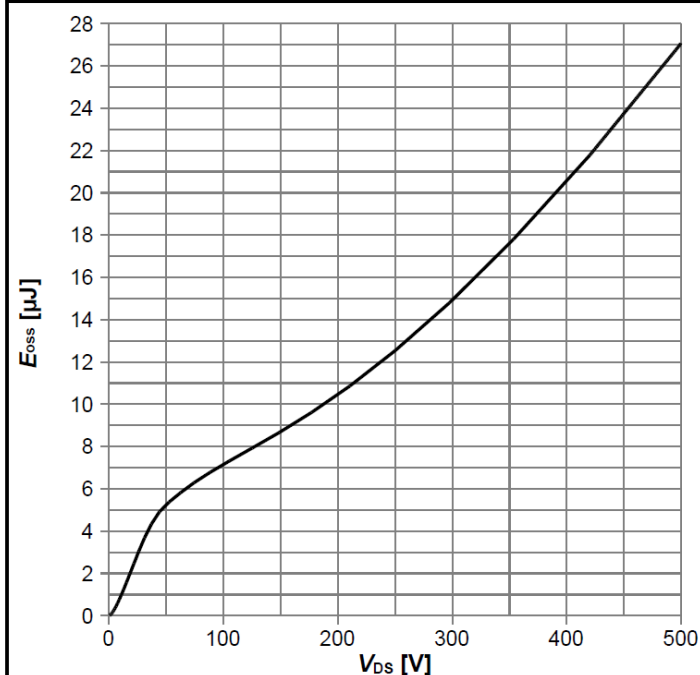
$$V_{BR(DSS)} = f(T_j); I_D = 1 \text{ mA}$$

Diagram 14: Typ. capacitances



$$C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$$

Diagram 15: Typ. C_{oss} stored energy



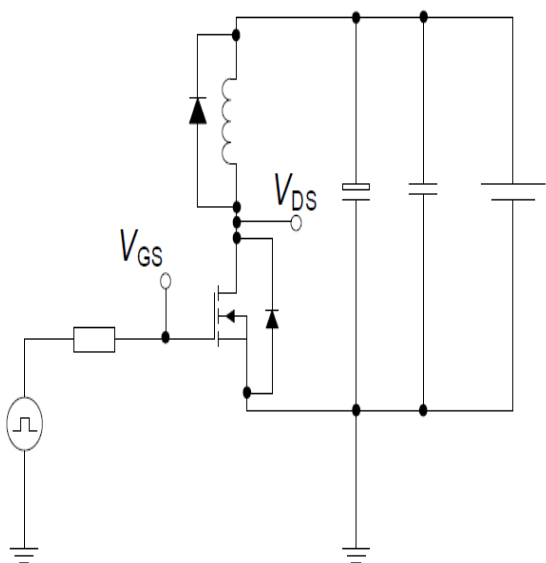
$$E_{oss} = f(V_{DS})$$



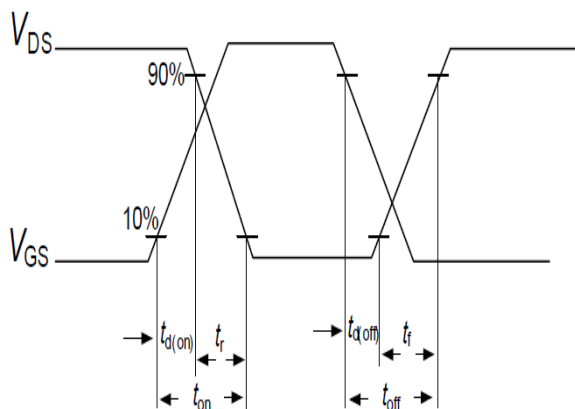
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Switching times test circuit and waveform for inductive load

Switching times test circuit for inductive load

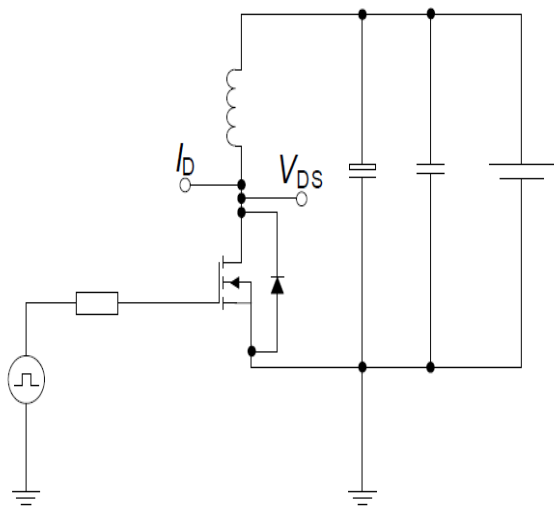


Switching time waveform

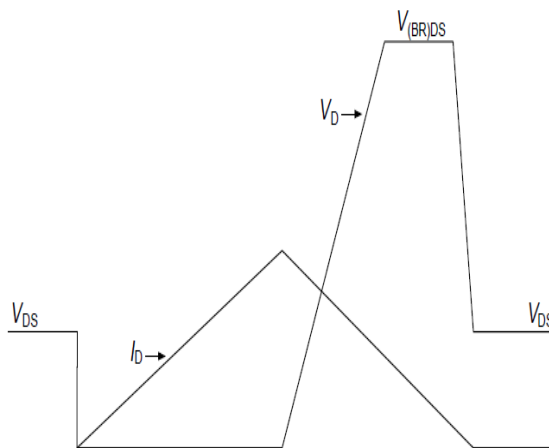


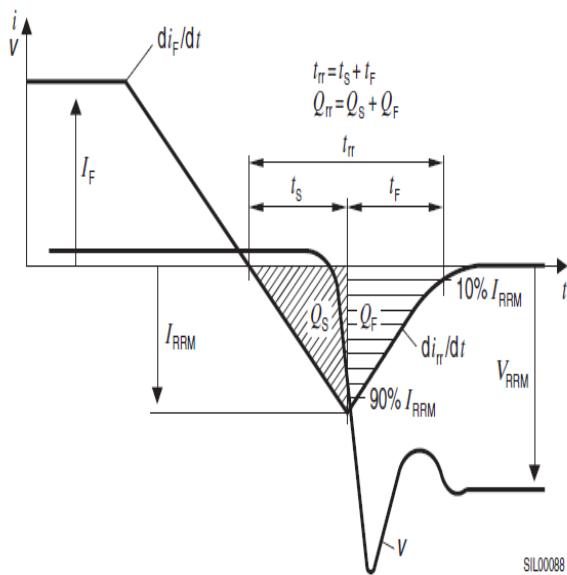
Unclamped inductive load test circuit and waveform

Unclamped inductive load test circuit



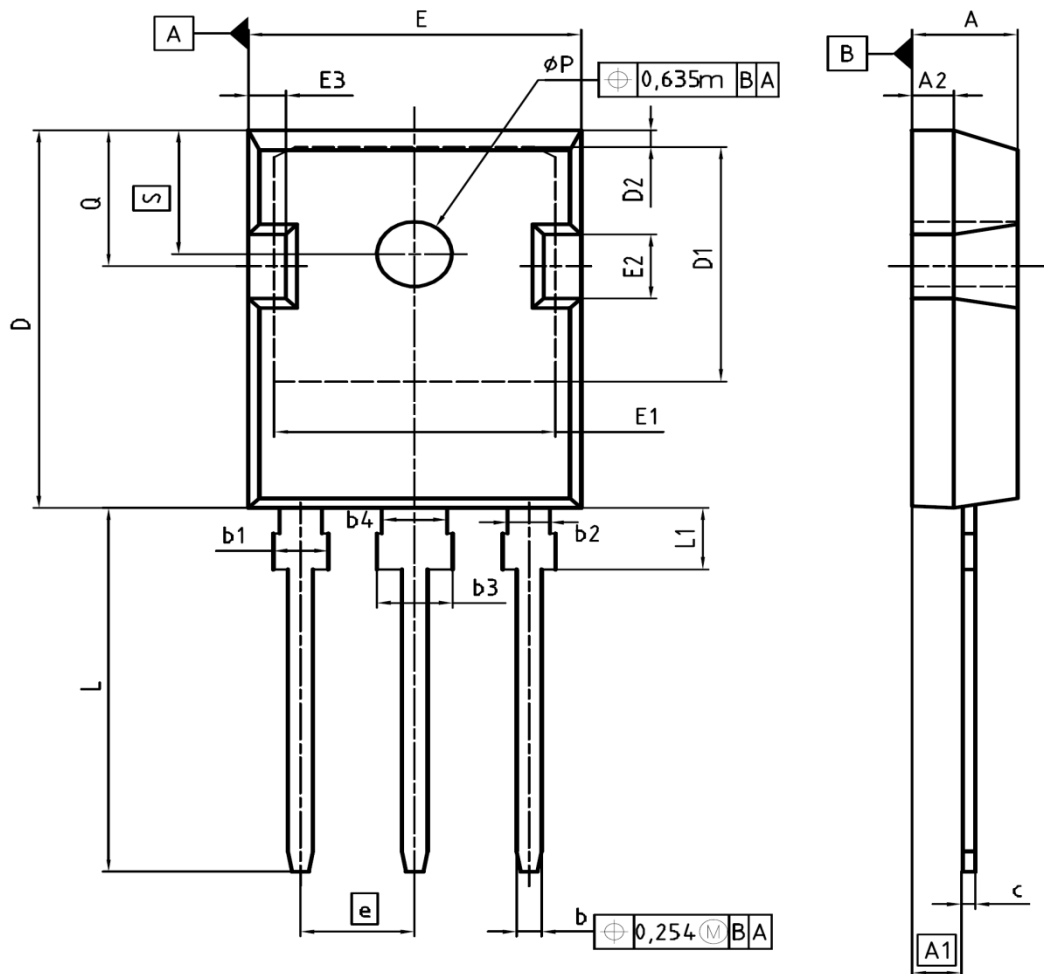
Unclamped inductive waveform







RTW77N60SD Super Junction MOSFETs



| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|-------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | 4.83 | 5.21 | 0.190 | 0.205 |
| A1 | 2.27 | 2.54 | 0.089 | 0.100 |
| A2 | 1.85 | 2.16 | 0.073 | 0.085 |
| b | 1.07 | 1.33 | 0.042 | 0.052 |
| b1 | 1.90 | 2.41 | 0.075 | 0.095 |
| b2 | 1.90 | 2.16 | 0.075 | 0.085 |
| b3 | 2.87 | 3.38 | 0.113 | 0.133 |
| b4 | 2.87 | 3.13 | 0.113 | 0.123 |
| c | 0.55 | 0.68 | 0.022 | 0.027 |
| D | 20.80 | 21.10 | 0.819 | 0.831 |
| D1 | 16.25 | 17.65 | 0.640 | 0.695 |
| D2 | 0.95 | 1.35 | 0.037 | 0.053 |
| E | 15.70 | 16.13 | 0.618 | 0.635 |
| E1 | 13.10 | 14.15 | 0.516 | 0.557 |
| E2 | 3.68 | 5.10 | 0.145 | 0.201 |
| E3 | 1.00 | 2.60 | 0.039 | 0.102 |
| e | 5.44 | | 0.214 | |
| N | 3 | | 3 | |
| L | 19.80 | 20.32 | 0.780 | 0.800 |
| L1 | 4.10 | 4.47 | 0.161 | 0.176 |
| øP | 3.50 | 3.70 | 0.138 | 0.146 |
| Q | 5.49 | 6.00 | 0.216 | 0.236 |
| S | 6.04 | 6.30 | 0.238 | 0.248 |

| |
|-----------------------------|
| DOCUMENT NO. Z8B00003327 |
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